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**PRODUCT BULLETIN**  
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**04 Sep 2007**

**SUBJECT: ON Semiconductor Product Bulletin #16043**

**TITLE: Discontinuance of Dry Pack for NUS3045MNT1G Product**

**PROPOSED FIRST SHIP DATE: 04 Sep 2007**

**AFFECTED PRODUCT DIVISION: Digital & Consumer Products Division**

**FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:**

Contact your local ON Semiconductor sales office or Shilpa Rao <[shilpa.rao@onsemi.com](mailto:shilpa.rao@onsemi.com)>

**NOTIFICATION TYPE:**

ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact your local ON Semiconductor sales office.

**DESCRIPTION AND PURPOSE:**

The temporary OA regarding the dry packing of device NUS3045MNT1G has expired. Product has shown compliance with Moisture Sensitivity Level 1 (MSL 1). Effective September 4, 2007, dry packing will be discontinued for NUS3045MNT1G & product will be shipped per MSL 1 packing.

**AFFECTED DEVICE LIST**

NUS3045MNT1G